Fully Depleted, Monolithic Pinned Photodiode CMOS Image Sensor Using Reverse Substrate Bias

Konstantin D. Stefanov, Andrew S. Clarke, James Ivory and Andrew D. Holland

Centre for Electronic Imaging, The Open University, Walton Hall, Milton Keynes, MK7 6AA, UK



The Open University, Walton Hall, MK7 6AA

http://www.open.ac.uk/cei Konstantin.Stefanov@open.ac.uk

Summary

A new pixel design using fully depleted pinned photodiode (PPD) in a 180 nm monolithic CMOS image sensor (CIS) process has been developed as a proof of principle. The sensor can be fully depleted by means of reverse bias applied to the substrate, and the principle of operation is applicable to very thick sensitive volumes. Additional n-type implants, called Deep Depletion Extension (DDE) under the in-pixel p-wells have been added to the manufacturing process in order to eliminate the large parasitic substrate current that would otherwise be present in a normal device. The new design exhibits nearly identical electro-optical performance under reverse bias as the reference PPD pixel it is based on, and the leakage current is effectively suppressed. The characterisation results from both front- and back-side illuminated sensor variants show that the epitaxial layer is fully depleted. This development has the potential to greatly increase the quantum efficiency of PPD CIS at near-infrared and soft X-ray wavelengths.



IISW2017, Hiroshima, Japan 30 May – 2 June 2017





'NE C2V iere**you**look"